Cemented wirewound resistors AC01/03/04/05/07/10/15/20

FEATURES

- High power dissipation in small volume
- High pulse load handling capabilities.

APPLICATIONS

- Ballast switching
- Shunt in small electric motors
- Power supplies.

DESCRIPTION

The resistor element is a resistive wire which is wound in a single layer on a ceramic rod. Metal caps are pressed over the ends of the rod. The ends of the resistance wire and the leads are connected to the caps by welding. Tinned copper-clad iron leads with poor heat conductivity are employed permitting the use of relatively short leads to obtain stable mounting without overheating the solder joint.

The resistor is coated with a green silicon cement which is not resistant to aggressive fluxes. The coating is non-flammable, will not drip even at high overloads and is resistant to most commonly used cleaning solvents, in accordance with *"MIL-STD-202E"* and *"IEC 60068-2-45"*.

QUICK REFERENCE DATA

DESCRIPTION	VALUE							
	AC01	**AC03**	**AC04**	**AC05**	**AC07**	**AC10**	**AC15**	**AC20**
Resistance range	0.1 Ω to 2 kΩ	0.1 Ω to 4.7 kΩ	0.1 Ω to 6.8 kΩ	0.1 Ω to 8.2 kΩ	0.1 Ω to 15 kΩ	0.68 Ω to 27 kΩ	0.82 Ω to 39 kΩ	1.2 Ω to 56 kΩ
Resistance tolerance	±5%; E24 series							
Maximum permissible body temperature	350 °C							
Rated dissipation at T_{amb} = 40 °C	1 W	3 W	4 W	5 W	7 W	10 W	15 W	20 W
Rated dissipation at T_{amb} = 70 °C	0.9 W	2.5 W	3.5 W	4.7 W	5.8 W	8.4 W	12.5 W	16 W
Climatic category (IEC 60068)	40/200/56							
Basic specification	IEC 60115-1							
Stability after:								
load, 1000 hours	ΔR/R max.: ±5% + 0.1 Ω							
climatic tests	ΔR/R max.: ±1% + 0.05 Ω							
short time overload	ΔR/R max.: ±2% + 0.1 Ω							

ORDERING INFORMATION

Table 1 Ordering code indicating resistor type and packaging

TYPE	ORDERING CODE 23..			
	LOOSE IN BOX	BANDOLIER IN AMMOPACK		
	STRAIGHT LEADS	RADIAL	STRAIGHT LEADS	
	500 units	2500 units	500 units	1000 units
AC01	–	06 328 90...(2)	–	06 328 33...
AC03(1)	–	–	22 329 03...	–
AC04(1)	–	–	22 329 04...	–
AC05(1)	–	–	22 329 05...	–
AC07(1)	–	–	22 329 07...	–
AC10	–	–	22 329 10...	–
AC15	22 329 15...	–	–	–
AC20	22 329 20...	–	–	–

Notes

1. Products with bent leads and loose in box, are available on request.
2. Last 3 digits available on request.

Ordering code (12NC)

- The resistors have a 12-digit ordering code starting with 23
- The subsequent 7 digits indicate the resistor type and packaging; see Table 1.
- The remaining 3 digits indicate the resistance value:
  - The first 2 digits indicate the resistance value.
  - The last digit indicates the resistance decade in accordance with Table 2.

Table 2 Last digit of 12NC

RESISTANCE DECADE	LAST DIGIT
0.1 to 0.91 Ω	7
1 to 9.1 Ω	8
10 to 91 Ω	9
100 to 910 Ω	1
1 to 9.1 kΩ	2
10 to 56 kΩ	3

ORDERING EXAMPLE

The ordering code of an AC01 resistor, value 47 Ω, supplied in ammopack of 1000 units is: 2306 328 33479.

Product specifications deviating from the standard values are available on request.

FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of ±5%.
The values of the E24 series are in accordance with *"IEC publication 60063"*.

Limiting values

TYPE	LIMITING VOLTAGE(1) (V)	LIMITING POWER (W)	
		T_{amb} = 40 °C	T_{amb} = 70 °C
AC01	$V = \sqrt{P_n \times R}$	1	0.9
AC03		3	2.5
AC04		4	3.5
AC05		5	4.7
AC07		7	5.8
AC10		10	8.4
AC15		15	12.5
AC20		20	16.0

Note

1. The maximum voltage that may be continuously applied to the resistor element, see *"IEC publication 60266"*.

The maximum permissible hot-spot temperature is 350 °C.

DERATING

The power that the resistor can dissipate depends on the operating temperature; see Fig.1.

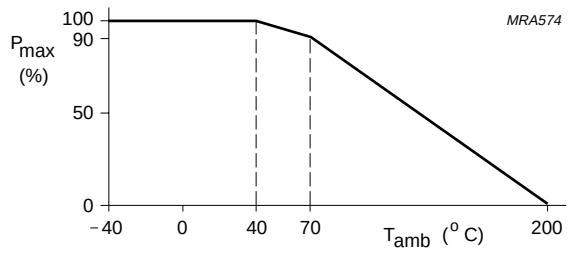
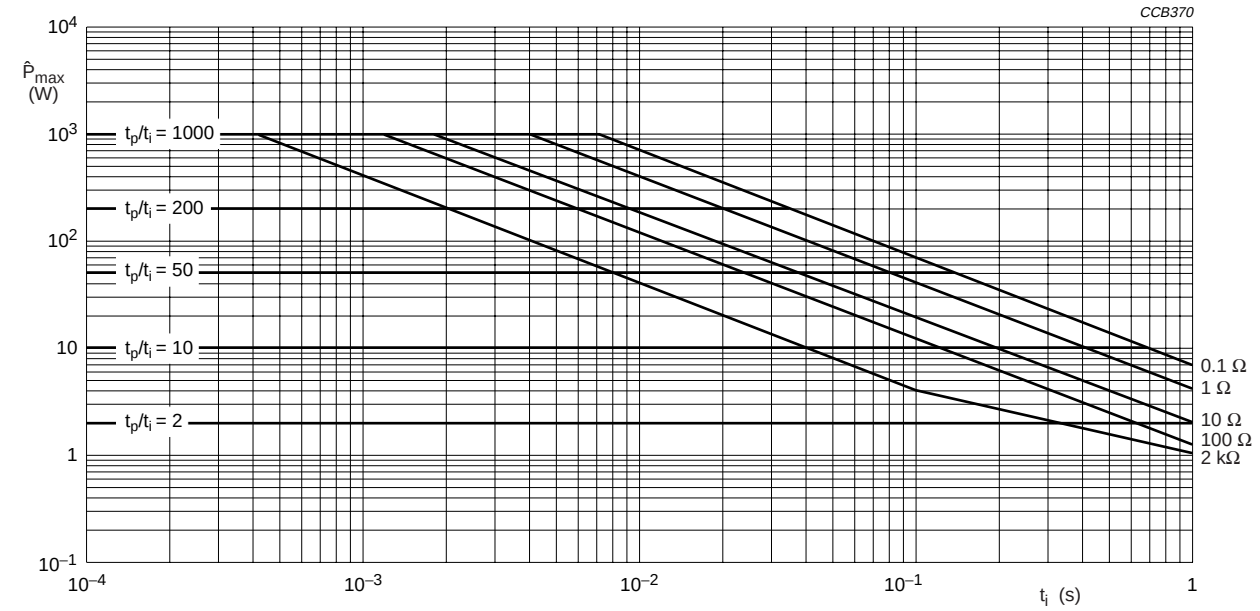


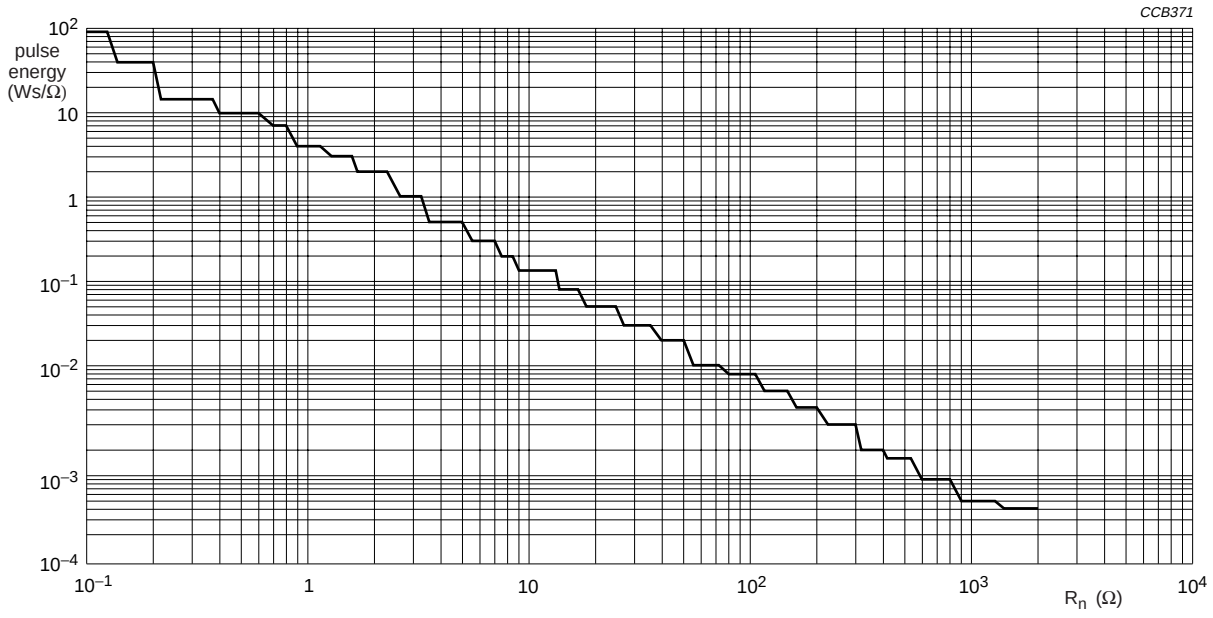
Fig.1 Maximum dissipation (P_{max}) as a function of the ambient temperature (T_{amb}).

PULSE LOADING CAPABILITIES



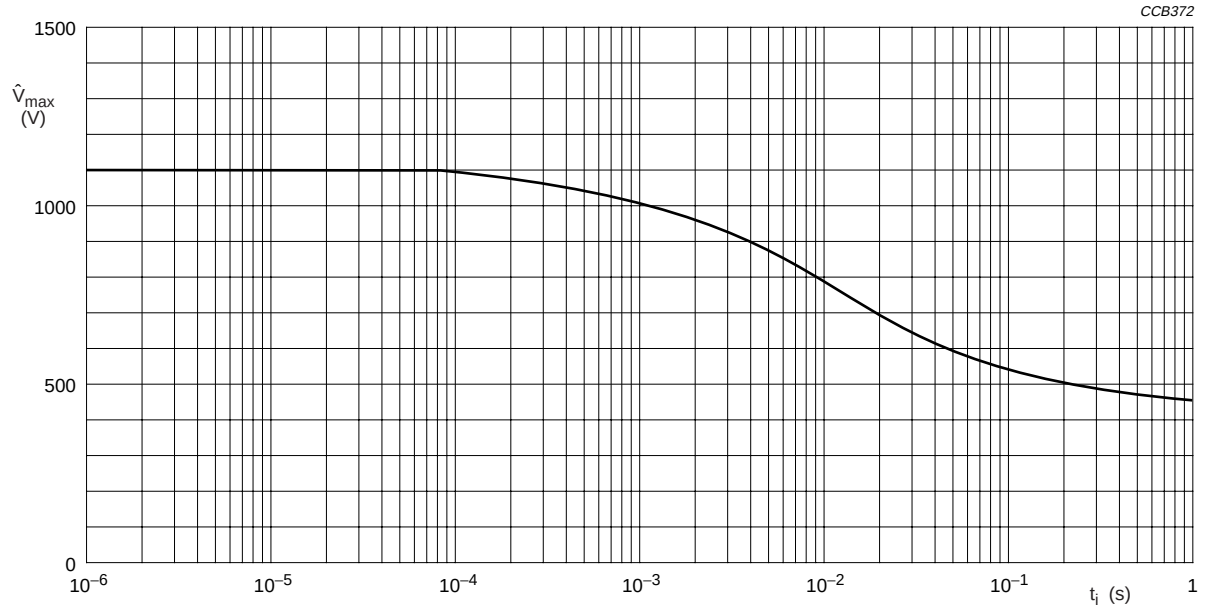
AC01

Fig.2 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max}$) as a function of pulse duration (t_i).



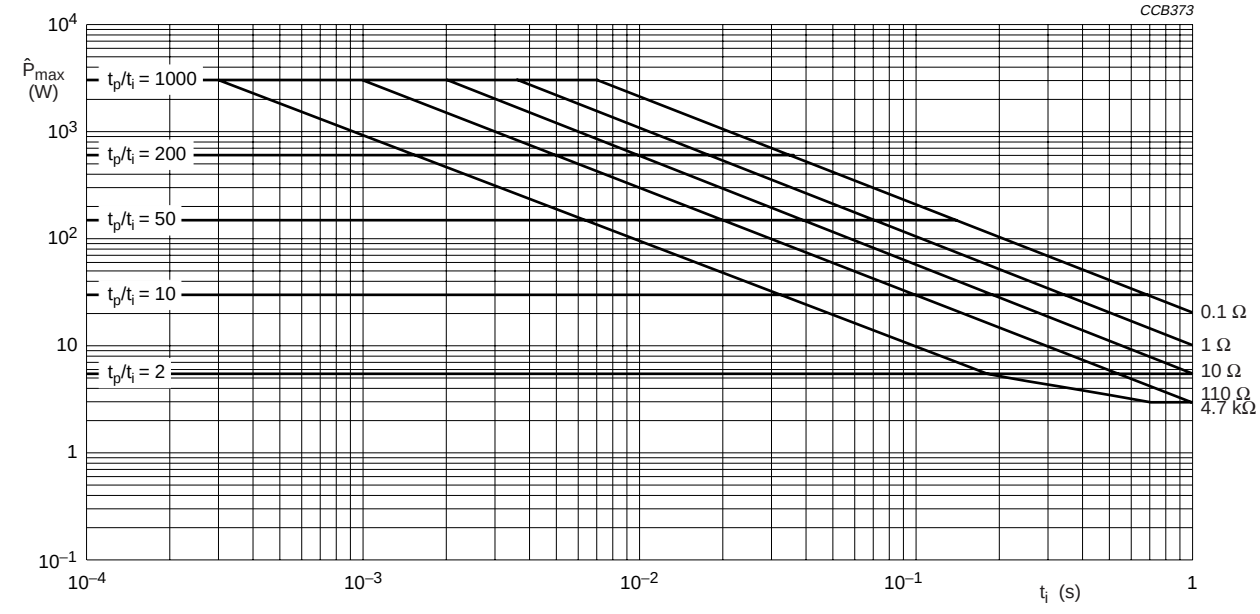
AC01

Fig.3 Pulse capability; Watt × seconds/ohm as a function of R_n.



AC01

Fig.4 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{V}_{max}$) as a function of pulse duration (t_i).



AC03

Fig.5 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max}$) as a function of pulse duration (t_i).

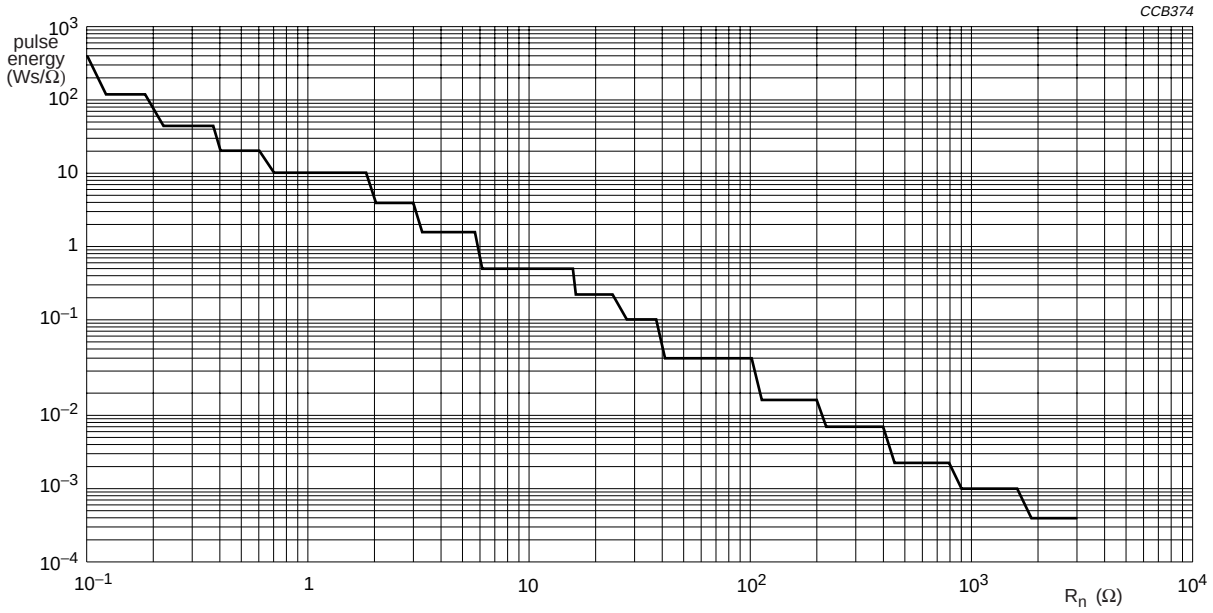


Fig.6 Pulse capability; Watt × seconds/ohm as a function of R_n.

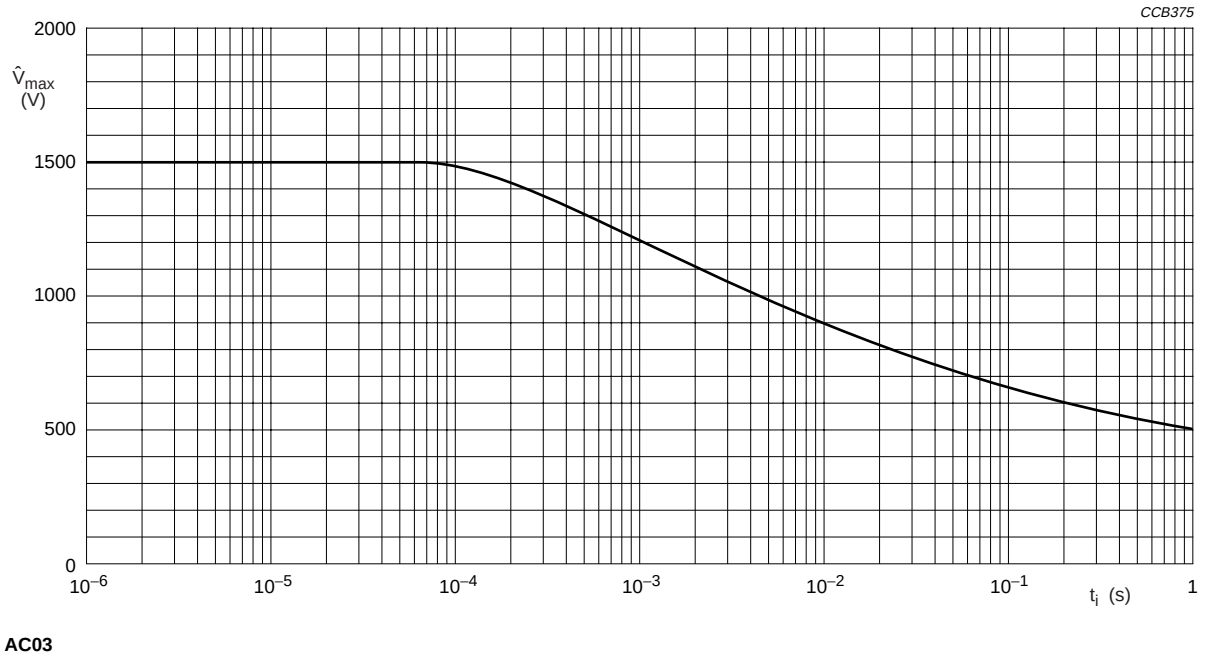


Fig.7 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{V}_{max}$) as a function of pulse duration (t_i).

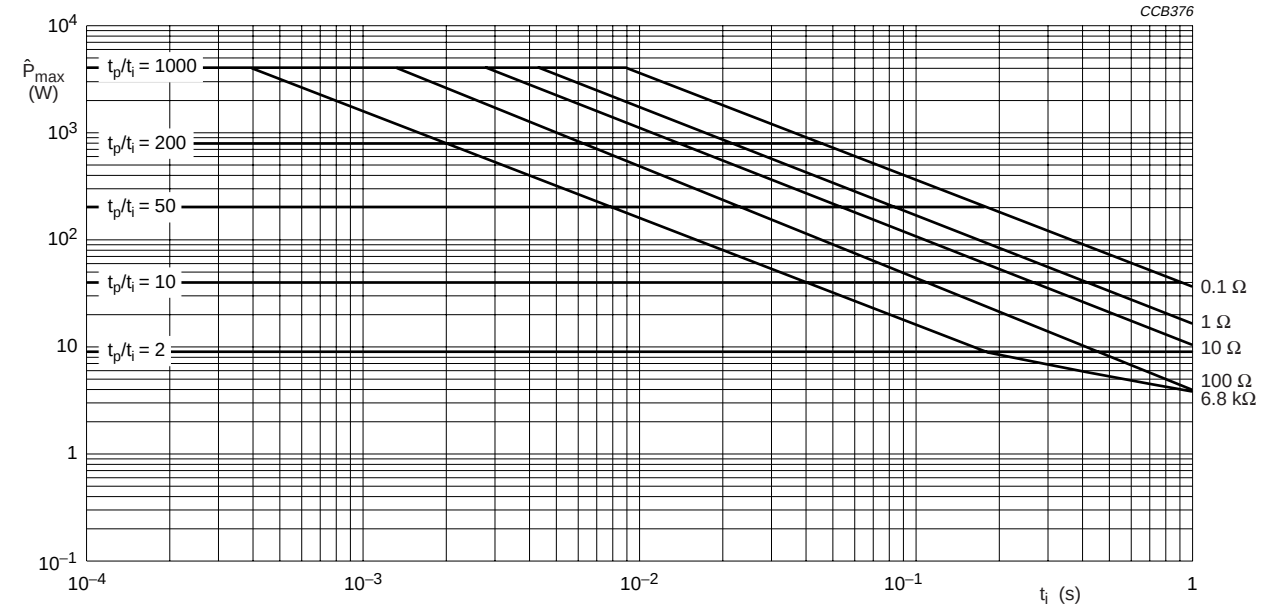


Fig.8 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max}$) as a function of pulse duration (t_i).

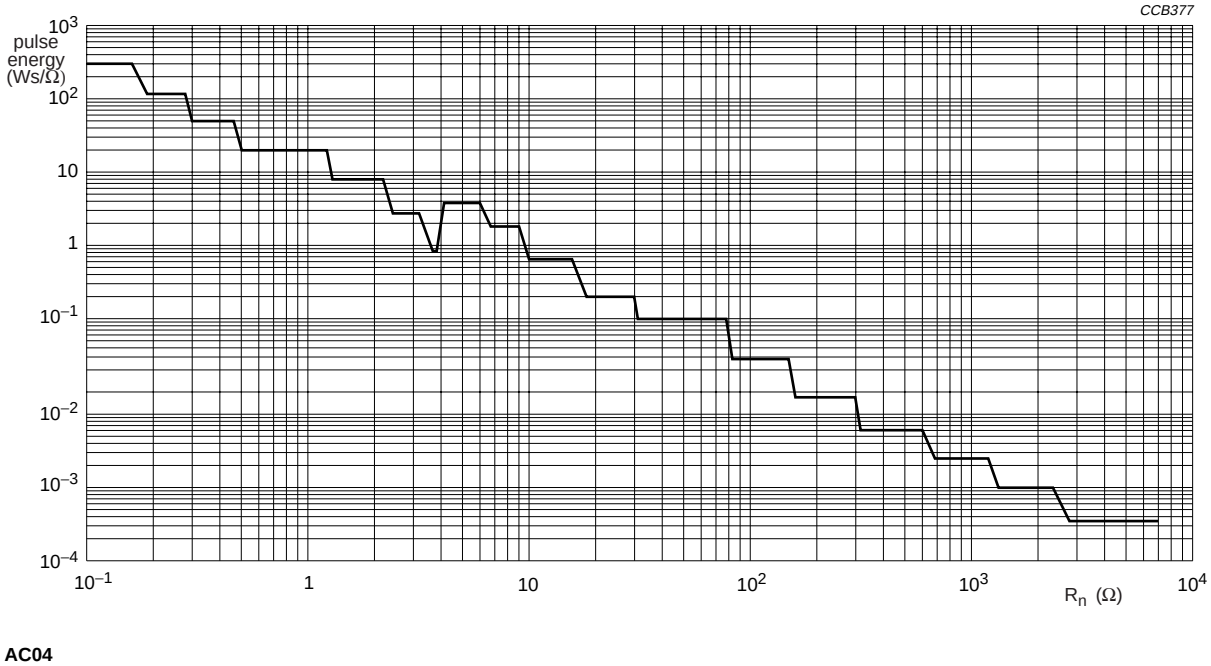


Fig.9 Pulse capability; Watt × seconds/ohm as a function of R_n.

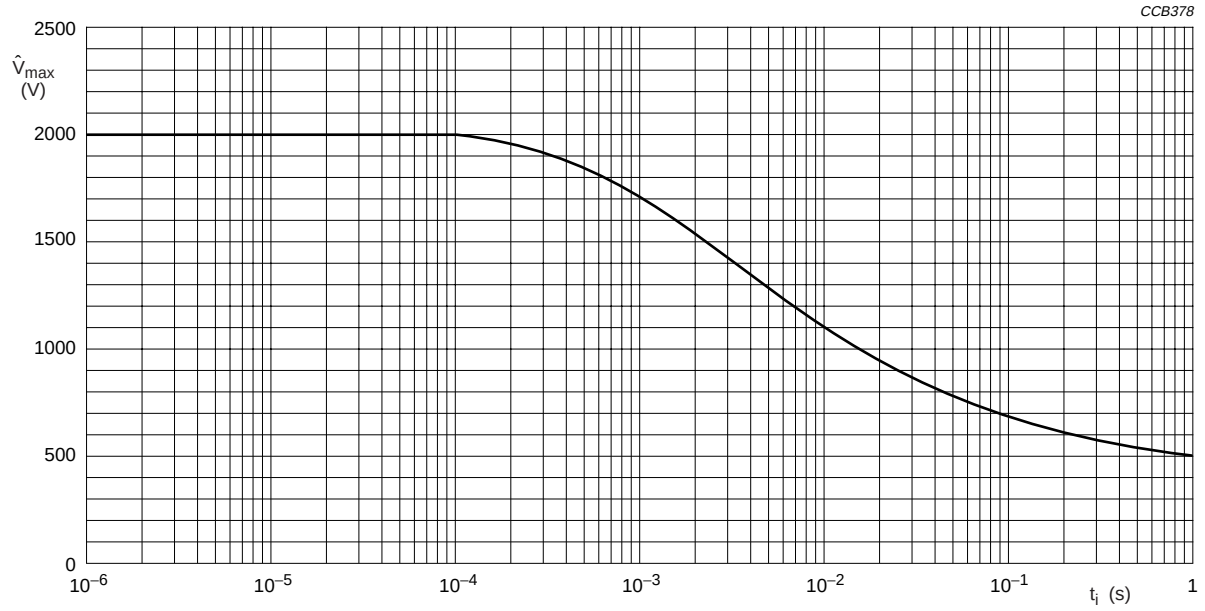


Fig.10 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{V}_{max}$) as a function of pulse duration (t_i).

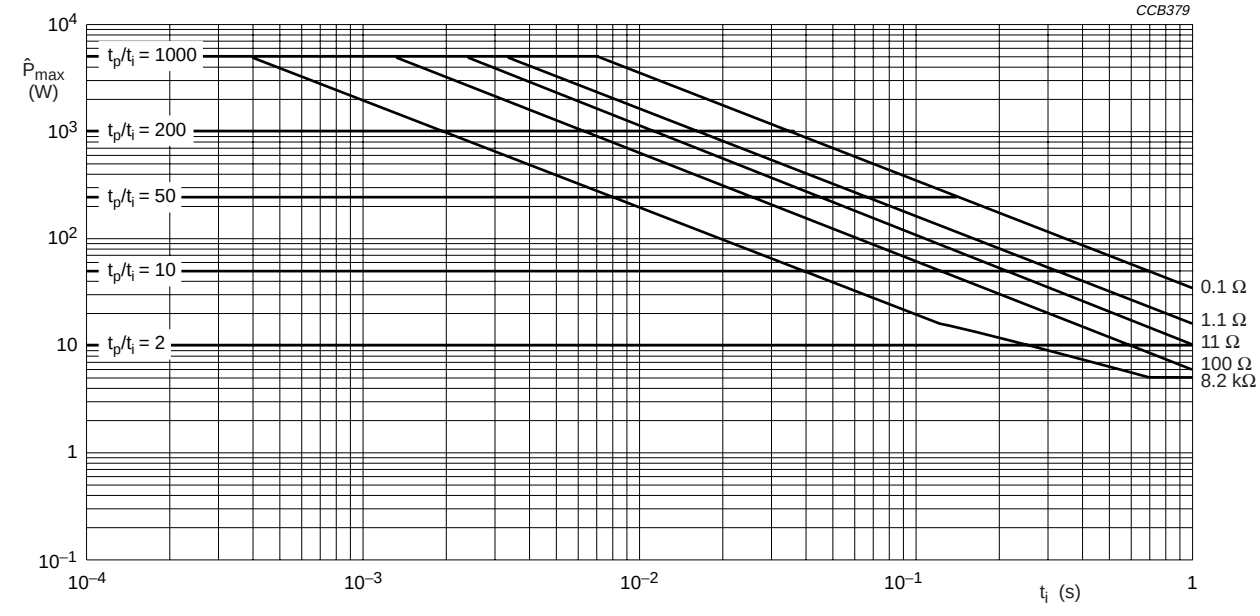


Fig.11 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max}$) as a function of pulse duration (t_i).

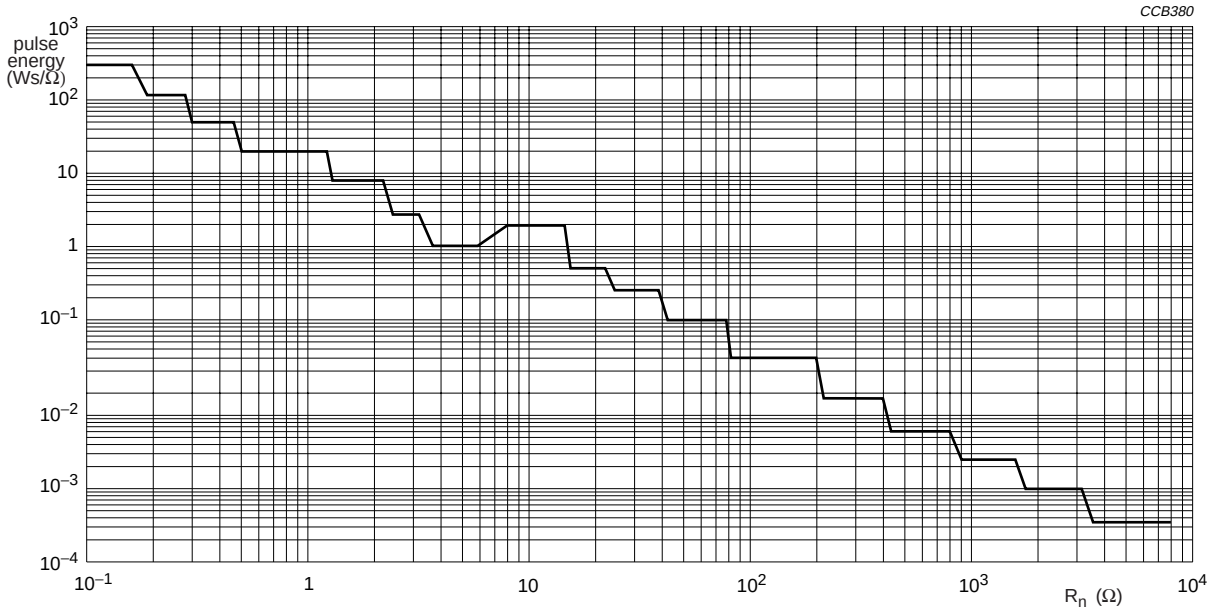


Fig.12 Pulse capability; Watt × seconds/ohm as a function of R_n.

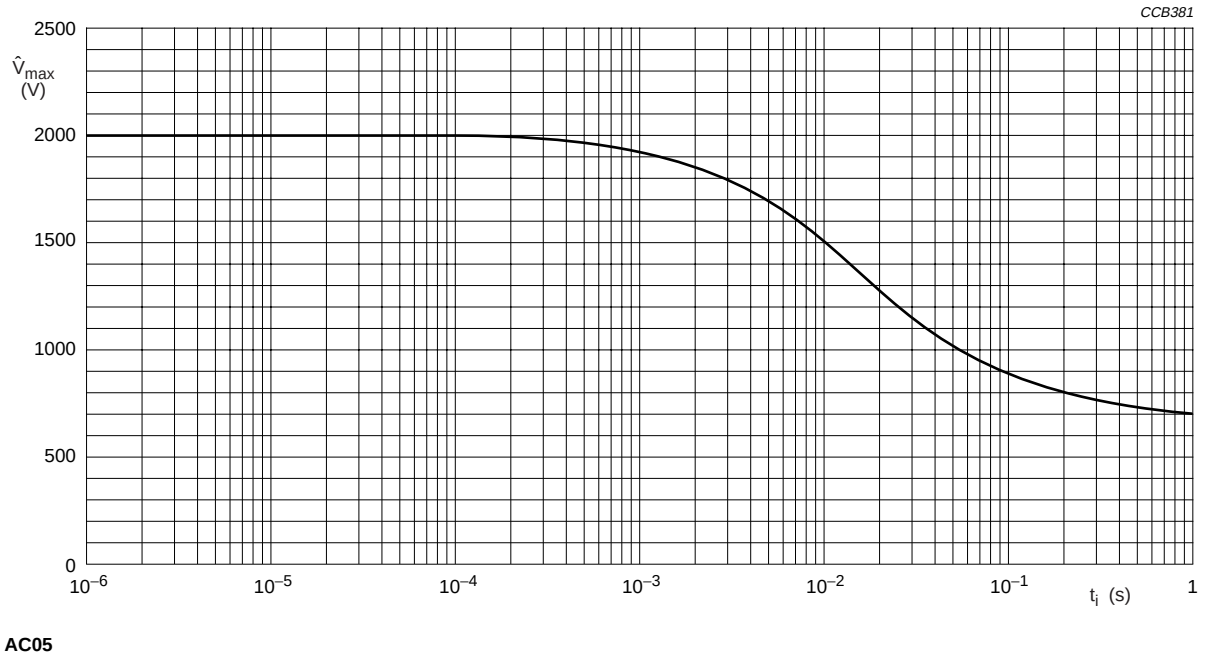


Fig.13 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{V}_{max}$) as a function of pulse duration (t_i).

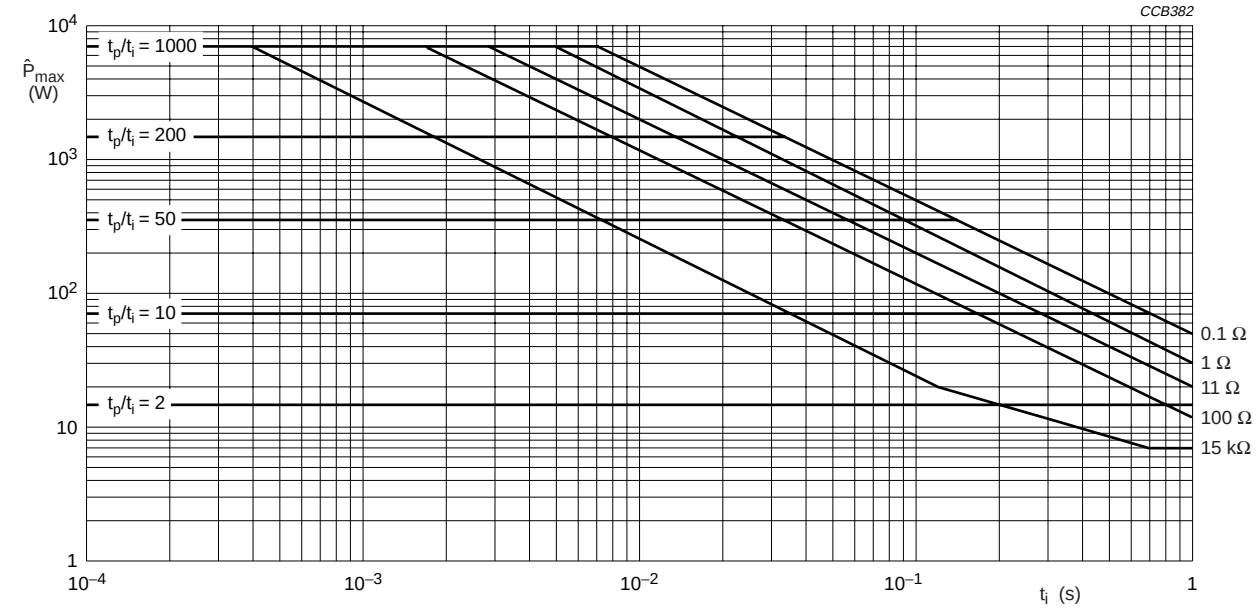


Fig.14 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max}$) as a function of pulse duration (t_i).

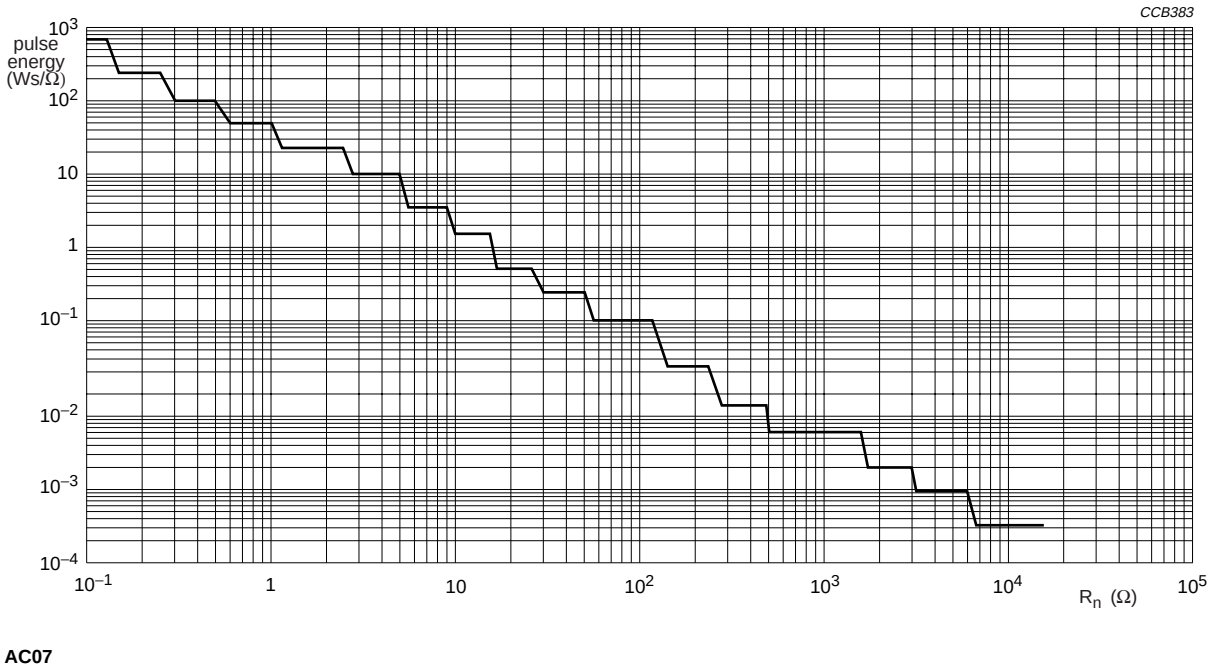


Fig.15 Pulse capability; Watt × seconds/ohm as a function of R_n.

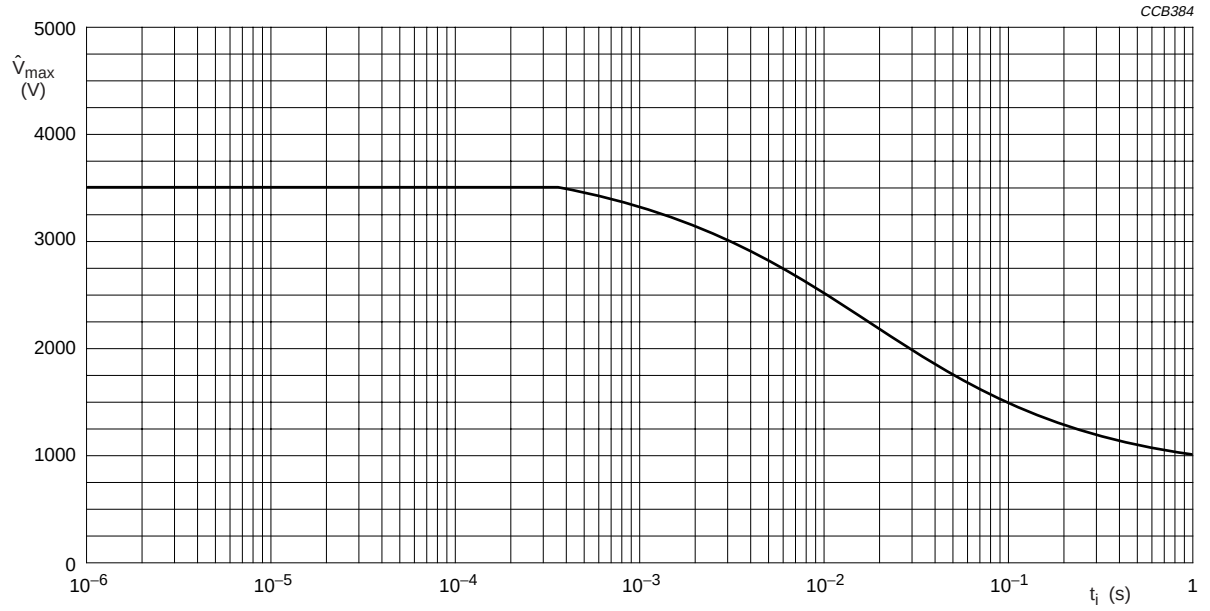


Fig.16 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{V}_{max}$) as a function of pulse duration (t_i).

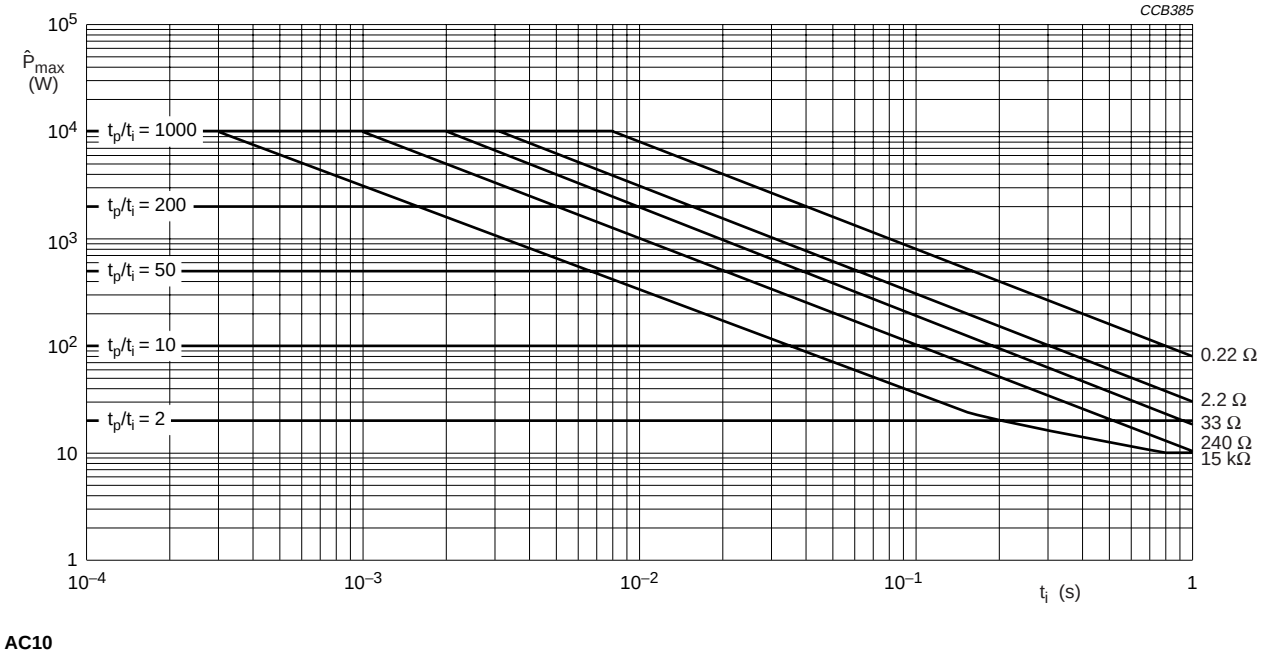


Fig.17 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max}$) as a function of pulse duration (t_i).

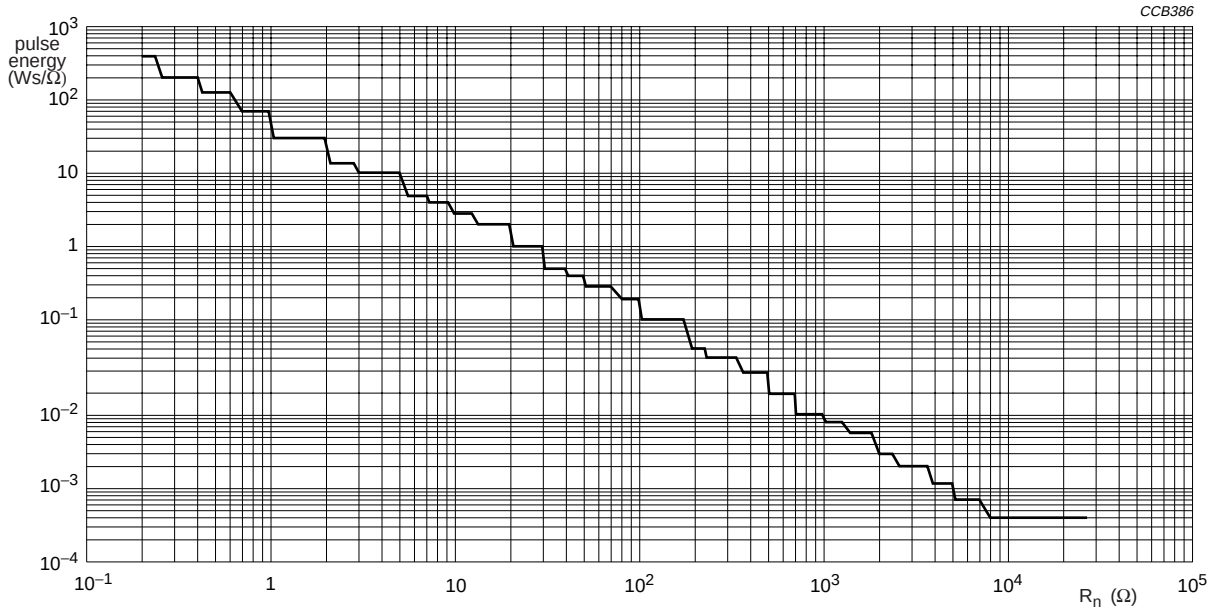


Fig.18 Pulse capability; Watt × seconds/ohm as a function of R_n.

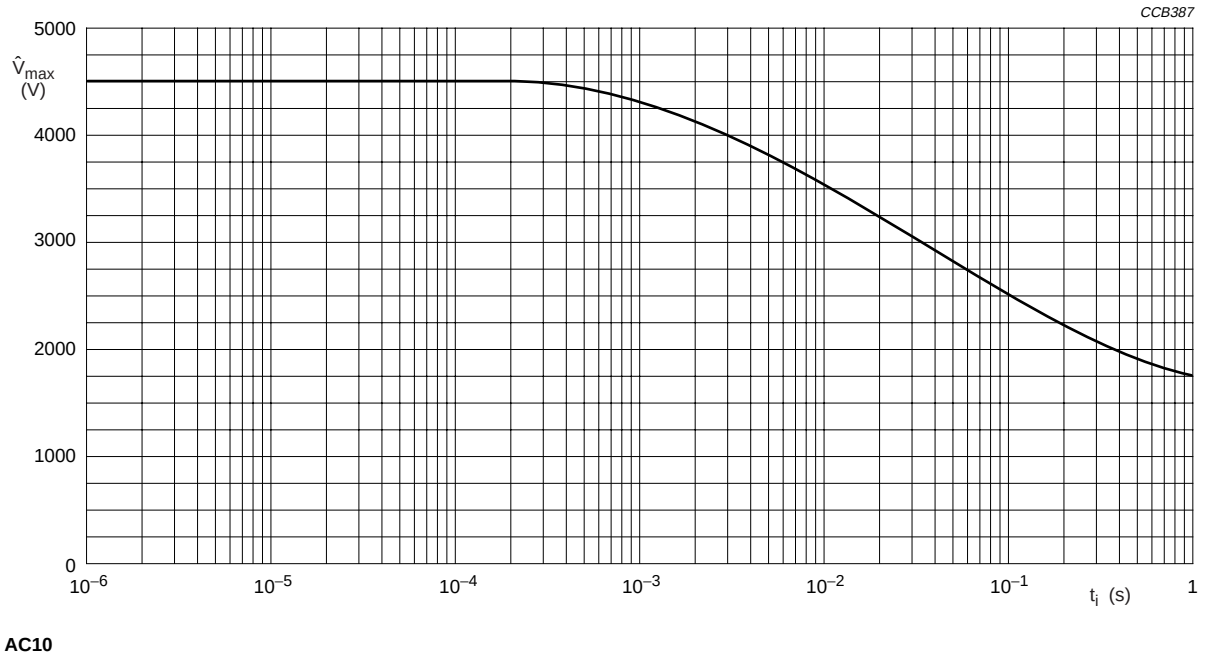


Fig.19 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{V}_{max}$) as a function of pulse duration (t_i).

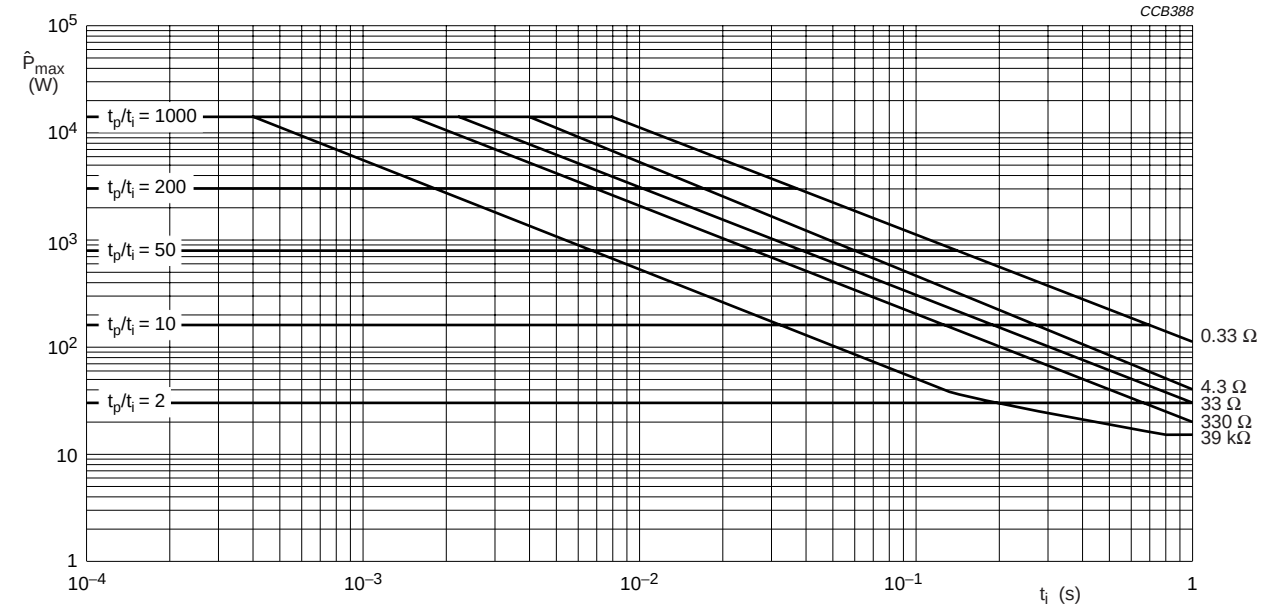


Fig.20 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max}$) as a function of pulse duration (t_i).

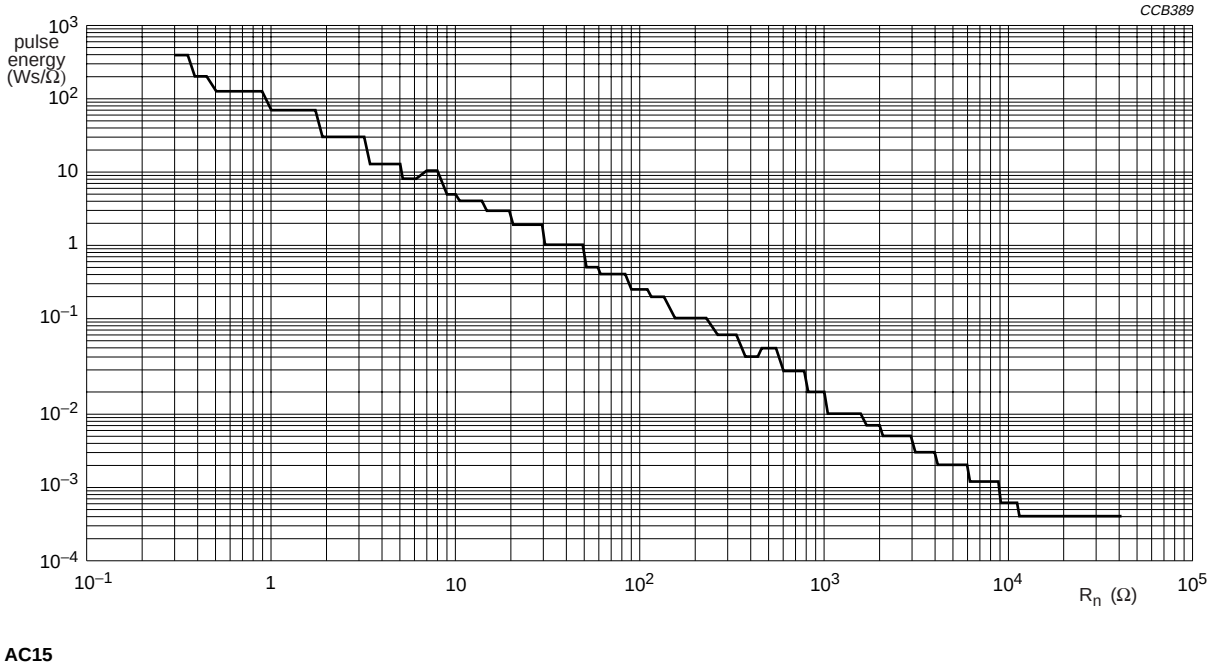


Fig.21 Pulse capability; Watt × seconds/ohm as a function of R_n.

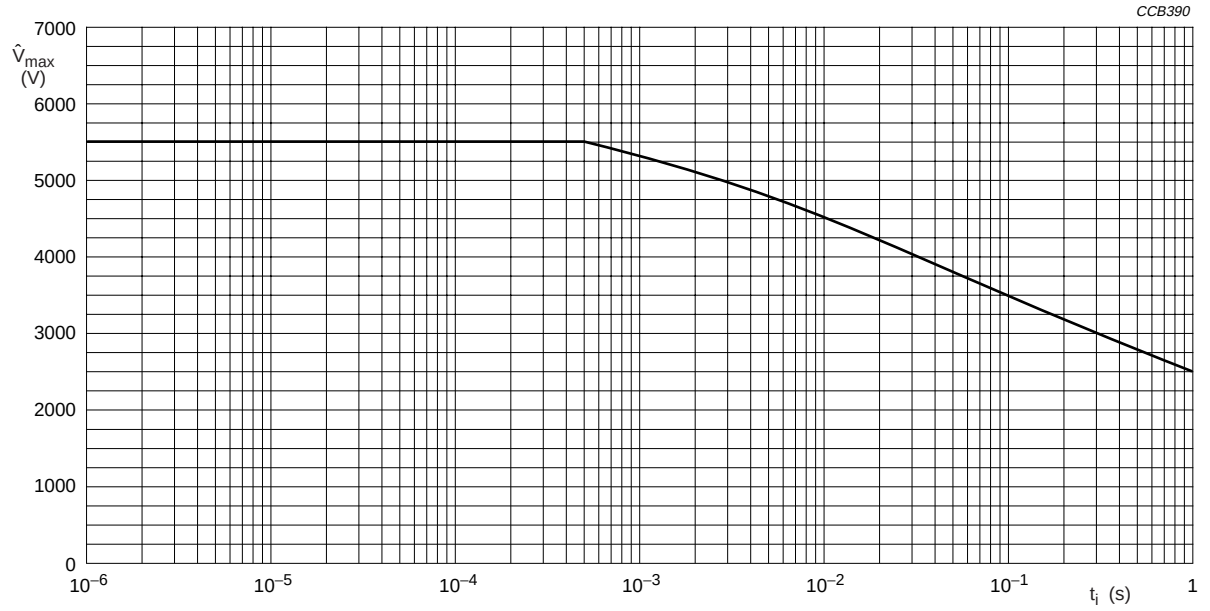


Fig.22 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{V}_{max}$) as a function of pulse duration (t_i).

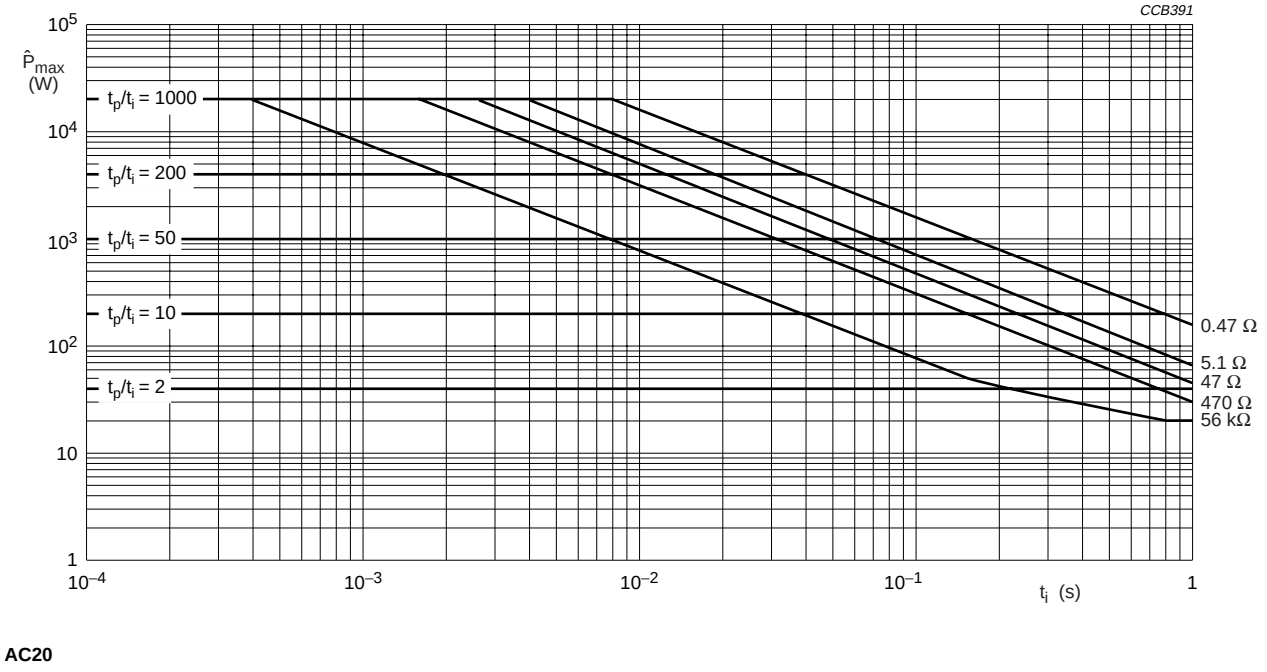


Fig.23 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max}$) as a function of pulse duration (t_i).

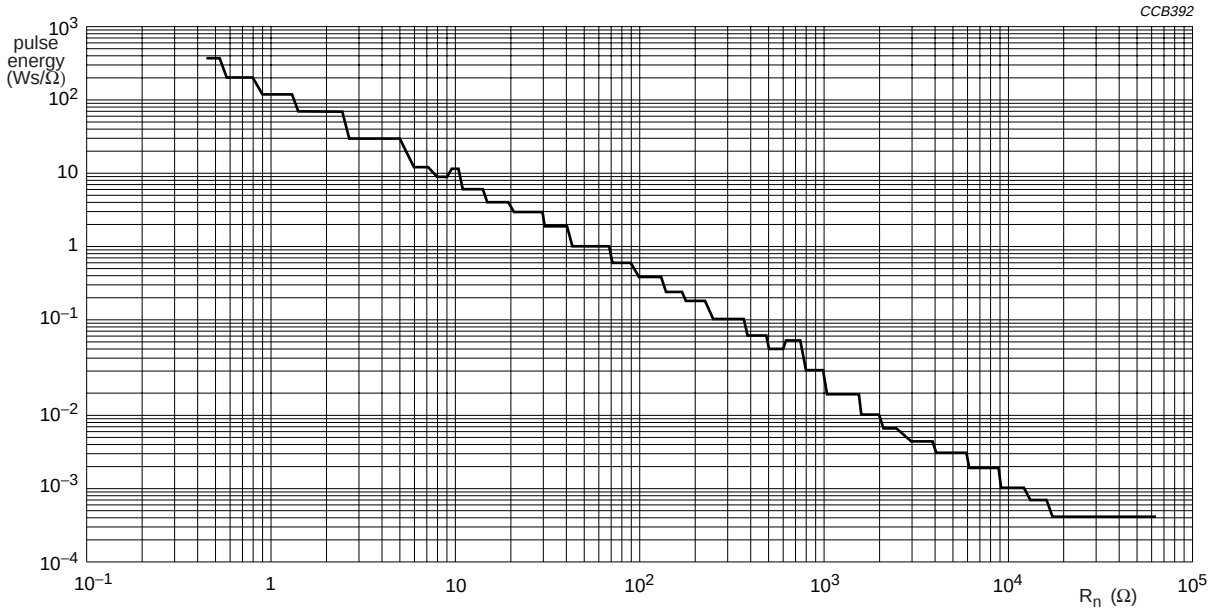


Fig.24 Pulse capability; Watt × seconds/ohm as a function of R_n.

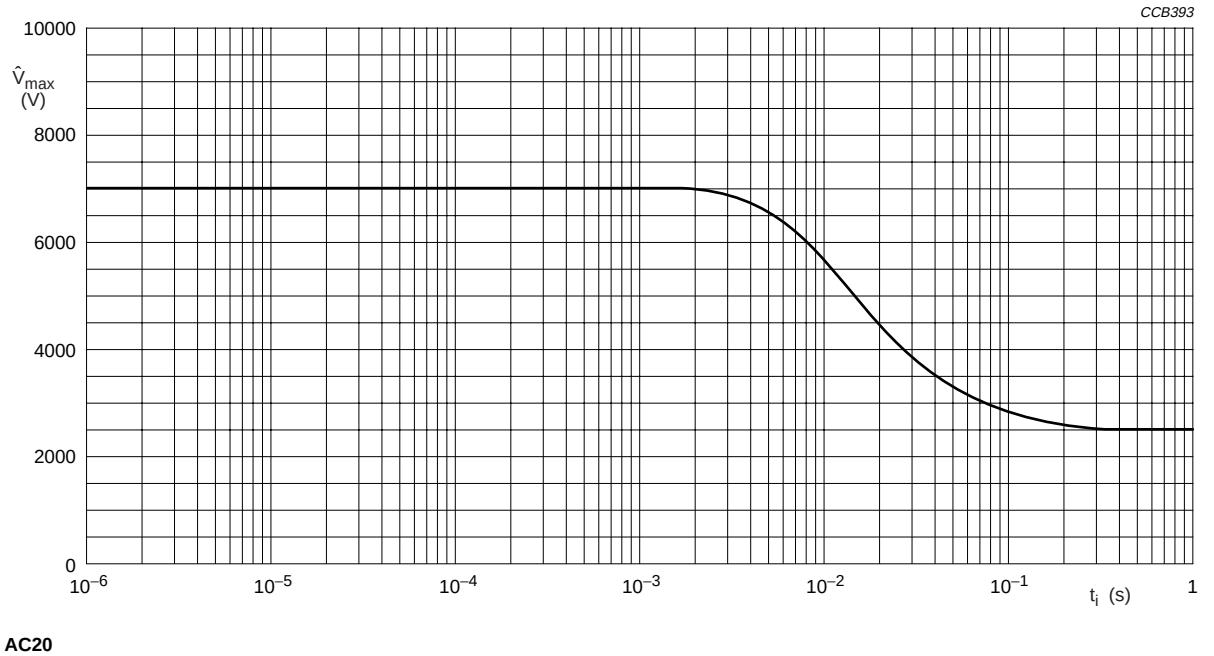


Fig.25 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{V}_{max}$) as a function of pulse duration (t_i).

Application information

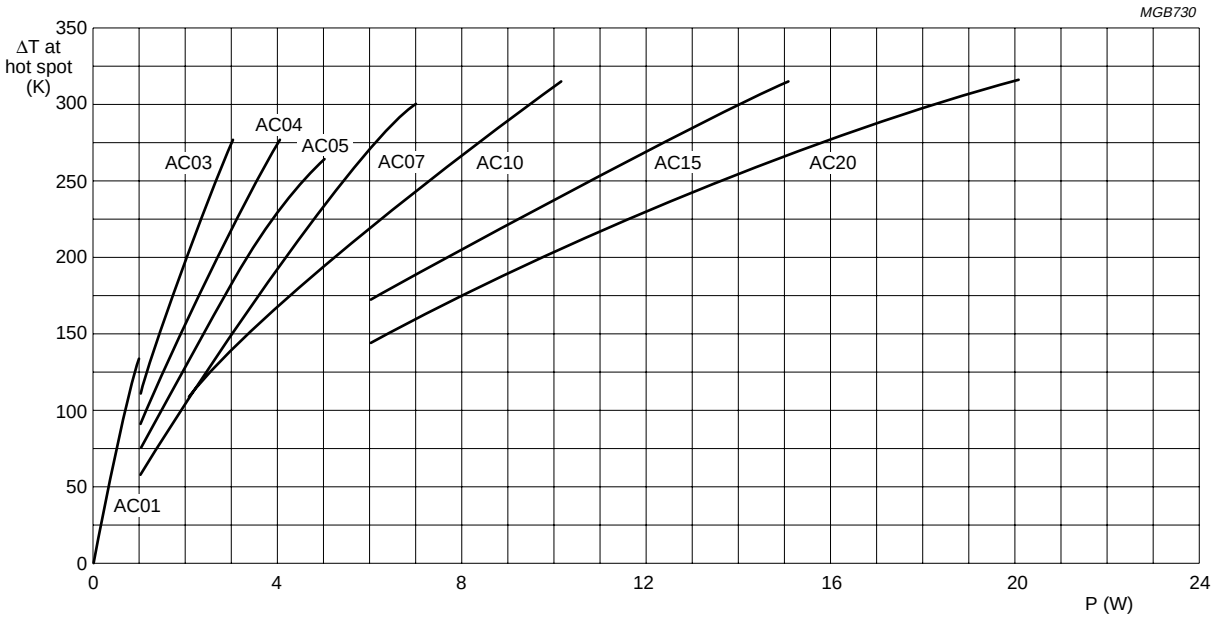
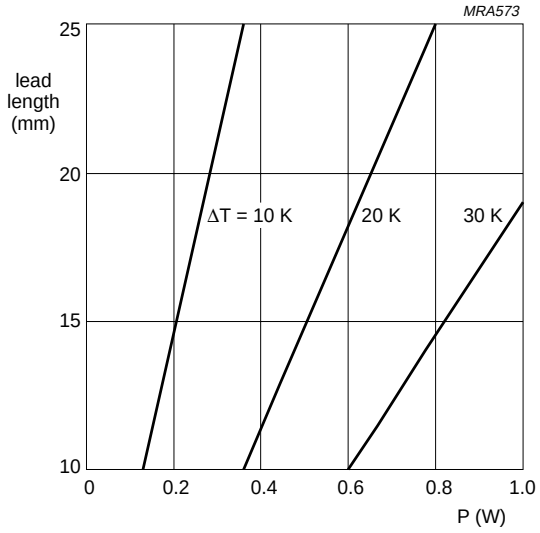
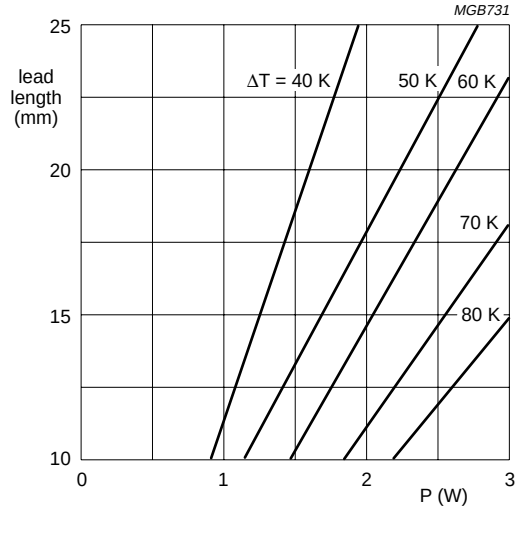


Fig.26 Temperature rise of the resistor body as a function of the dissipation.



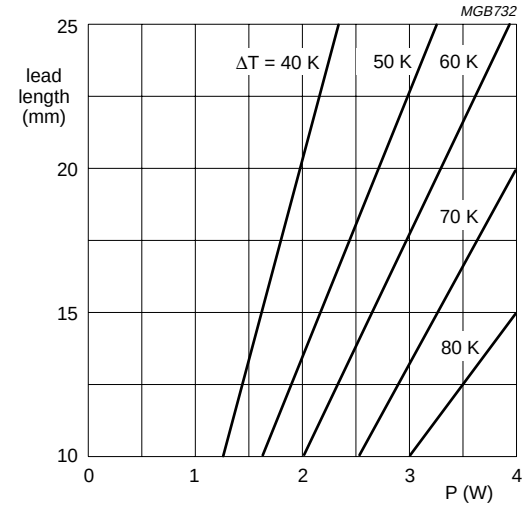
AC01

Fig.27 Lead length as a function of the dissipation with the temperature rise at the end of the lead (soldering spot) as a parameter.



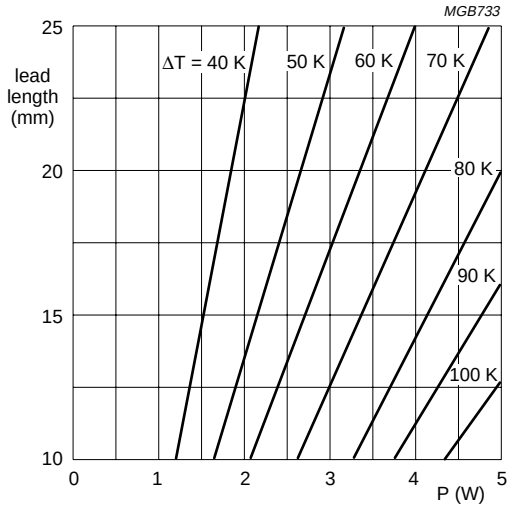
AC03

Fig.28 Lead length as a function of the dissipation with the temperature rise at the end of the lead (soldering spot) as a parameter.



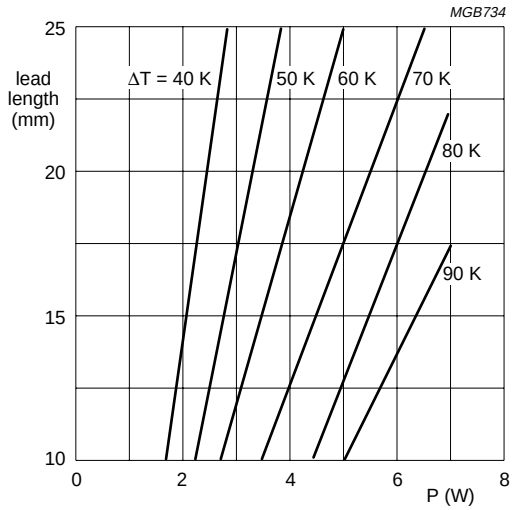
AC04

Fig.29 Lead length as a function of the dissipation with the temperature rise at the end of the lead (soldering spot) as a parameter.



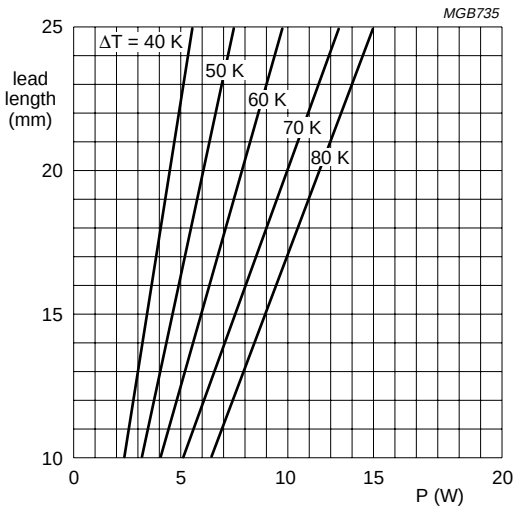
AC05

Fig.30 Lead length as a function of the dissipation with the temperature rise at the end of the lead (soldering spot) as a parameter.



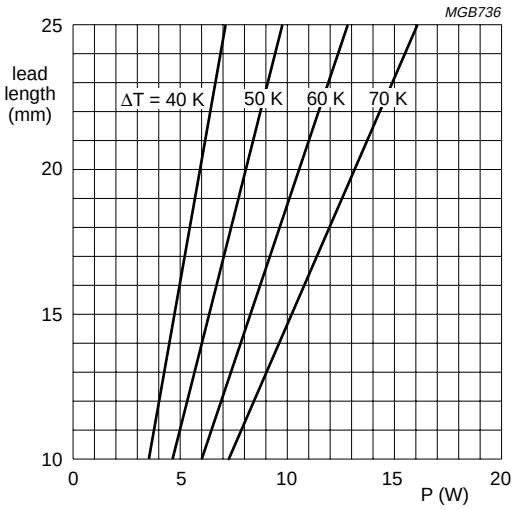
AC07

Fig.31 Lead length as a function of the dissipation with the temperature rise at the end of the lead (soldering spot) as a parameter.



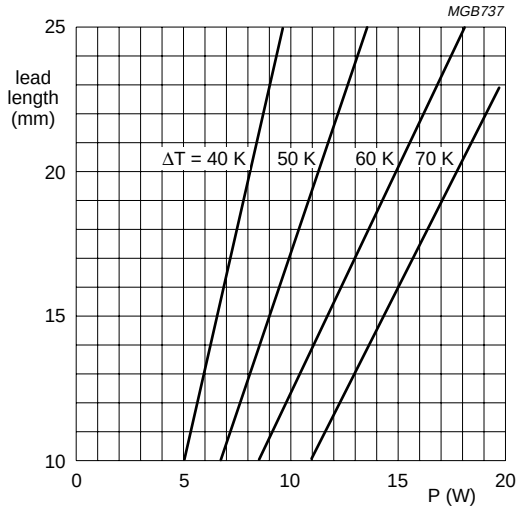
AC10

Fig.32 Lead length as a function of the dissipation with the temperature rise at the end of the lead (soldering spot) as a parameter.



AC15

Fig.33 Lead length as a function of the dissipation with the temperature rise at the end of the lead (soldering spot) as a parameter.



AC20

Fig.34 Lead length as a function of the dissipation with the temperature rise at the end of the lead (soldering spot) as a parameter.

MOUNTING

The resistor is suitable for processing on cutting and bending machines. **Ensure that the temperature rise of the resistor body does not affect nearby components or materials by conducted or convected heat.** Figure 26 shows the hot-spot temperature rise of the resistor body as a function of dissipated power. Figures 27 to 34 show the lead length as a function of dissipated power and temperature rise.

MECHANICAL DATA

Mass per 100 units

TYPE	MASS (g)
AC01	55
AC03	110
AC04	140
AC05	220
AC07	300
AC10	530
AC15	840
AC20	1090

Marking

The resistor is marked with the nominal resistance value, the tolerance on the resistance and the rated dissipation at T_{amb} = 40 °C.

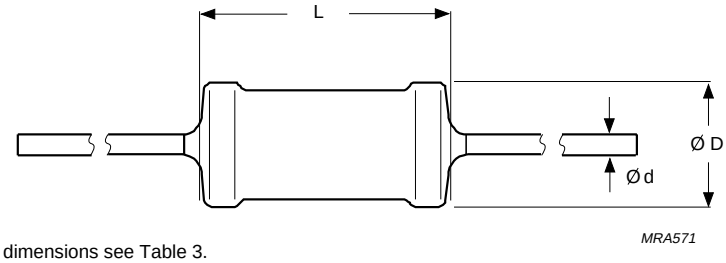
For values up to 910 Ω, the R is used as the decimal point.

For values of 1 kΩ and upwards, the letter K is used as the decimal point for the kΩ indication.

Outlines

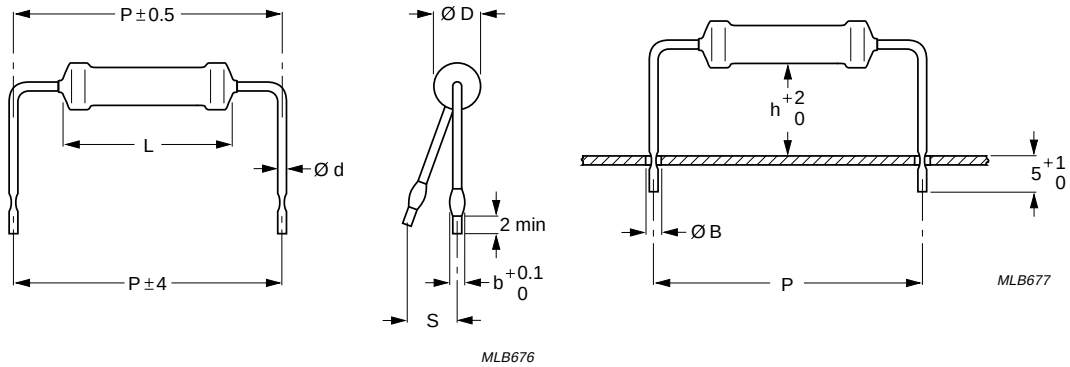
Table 3 Resistor type and relevant physical dimensions; see Figs 35 and 36

TYPE	∅D MAX. (mm)	L MAX. (mm)	∅d (mm)	b (mm)	h (mm)	P (mm)	S MAX. (mm)	∅B MAX. (mm)
AC01	4.3	10	0.8 ±0.03	–	–	–	–	–
AC03	5.5	13		1.3	8	10e	2	1.2
AC04	5.7	17						
AC05	7.5	17						
AC07	7.5	25				13e		
AC10	8	44		–	–	–	–	–
AC15	10	51		–	–	–	–	–
AC20	10	67		–	–	–	–	–



For dimensions see Table 3.

Fig.35 Type with straight leads.



Dimensions in mm.

For dimensions see Table 3.

Available on request for types: **AC03, AC04, AC05 and AC07**.

Fig.36 Type with cropped and formed leads.

TESTS AND REQUIREMENTS

Essentially all tests are carried out in accordance with the schedule of "*IEC publications 60115-1 and 60115-4"*, category 40/200/56 (rated temperature range –40 °C to +200 °C; damp heat, long term, 56 days). The testing also covers the requirements specified by EIA and EIAJ.

The tests are carried out in accordance with IEC publication 60068, *"Recommended basic climatic and mechanical robustness testing procedure for electronic components"* and under standard atmospheric conditions according to *"IEC 60068-1"*, subclause 5.3.

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C

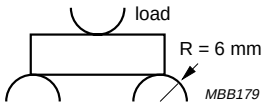
Relative humidity: 45% to 75%

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

In Table 4 the tests and requirements are listed with reference to the relevant clauses of *"IEC publications 60115-1, 115-4 and 68"*; a short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with mildly activated flux.

Table 4 Test procedures and requirements

IEC 60115-1 CLAUSE	IEC 60068 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
Tests in accordance with the schedule of IEC publication 60115-1				
4.15		robustness of resistor body	load 200 ±10 N 	no visible damage ΔR/R max.: ±0.5% + 0.05 Ω
4.16	U	robustness of terminations:		
	Ua	tensile all samples	load 10 N; 10 s	
	Ub	bending half number of samples	load 5 N 90°, 180°, 90°	
	Uc	torsion other half of samples	2 × 180° in opposite directions	no visible damage ΔR/R max.: ±0.5% + 0.05 Ω
4.17	Ta	solderability	2 s; 235 °C; flux 600	good tinning; no damage
4.18	Tb	resistance to soldering heat	thermal shock: 3 s; 350 °C; 2.5 mm from body	ΔR/R max.: ±0.5% + 0.05 Ω
4.19	14 (Na)	rapid change of temperature	30 minutes at –40 °C and 30 minutes at +200 °C; 5 cycles	no visible damage ΔR/R max.: ±1% + 0.05 Ω
4.22	Fc	vibration	frequency 10 to 500 Hz; displacement 0.75 mm or acceleration 10 g; 3 directions; total 6 hours (3 × 2 hours)	no damage ΔR/R max.: ±0.5% + 0.05 Ω
4.20	Eb	bump	4000 ±10 bumps; 390 m/s^2	no damage ΔR/R max.: ±0.5% + 0.05 Ω

IEC 60115-1 CLAUSE	IEC 60068 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
4.23		climatic sequence:		
4.23.2	Ba	dry heat	16 hours; 200 °C	
4.23.3	Db	damp heat (accelerated) 1st cycle	24 hours; 55 °C; 95 to 100% RH	
4.23.4	Aa	cold	2 hours; –40 °C	
4.23.5	M	low air pressure	1 hour; 8.5 kPa; 15 to 35 °C	
4.23.6	Db	damp heat (accelerated) remaining cycles	5 days; 55 °C; 95 to 100% RH	$\Delta R/R$ max.: ±1% + 0.05 Ω
4.24.2	3 (Ca)	damp heat (steady state)	56 days; 40 °C; 90 to 95% RH; dissipation ≤0.01 P_n	no visible damage $\Delta R/R$ max.: ±1% + 0.05 Ω
4.8.4.2		temperature coefficient	at 20/–40/20 °C, 20/200/20 °C: R < 10 Ω R ≥ 10 Ω	 TC ≤ $\pm 600 \times 10^{-6}$/K $-80 \times 10^{-6} \leq$ TC ≤ $+140 \times 10^{-6}$/K
		temperature rise	horizontally mounted, loaded with P_n	hot-spot temperature less than maximum body temperature
4.13		short time overload	room temperature; dissipation $10 \times P_n$; 5 s (voltage not more than 1000 V/25 mm)	$\Delta R/R$ max.: ±2% + 0.1 Ω
4.25.1		endurance (at 40 °C)	1000 hours loaded with P_n; 1.5 hours on and 0.5 hours off	no visible damage $\Delta R/R$ max.: ±5% + 0.1 Ω
4.25.1		endurance (at 70 °C)	1000 hours loaded with 0.9 P_n; 1.5 hours on and 0.5 hours off	no visible damage $\Delta R/R$ max.: ±5% + 0.1 Ω
4.23.2	27 (Ba)	endurance at upper category temperature	1000 hours; 200 °C; no load	no visible damage $\Delta R/R$ max.: ±5% + 0.1 Ω

IEC 60115-1 CLAUSE	IEC 60068 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
Other tests in accordance with IEC 60115 clauses and IEC 60068 test method				
4.29	45 (Xa)	component solvent resistance	70% 1.1.2 trichlorotrifluoroethane and 30% isopropyl alcohol; H_20	no visible damage
4.18	20 (Tb)	resistance to soldering heat	10 s; 260 ±5 °C; flux 600	$\Delta R/R$ max.: ±0.5% + 0.05 Ω
4.17	20 (Tb)	solderability (after ageing)	16 hours steam or 16 hours at 155 °C; 2 ±0.5 s in solder at 235 ±5 °C; flux 600	good tinning (≥95% covered); no damage
4.5		tolerance on resistance	applied voltage (±10%): R < 10 Ω: 0.1 V 10 Ω ≤ R < 100 Ω: 0.3 V 100 Ω ≤ R < 1 kΩ: 1 V 1 kΩ ≤ R < 10 kΩ: 3 V 10 kΩ ≤ R ≤ 33 kΩ: 10 V	$R - R_{nom}$: ±5% max.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

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